

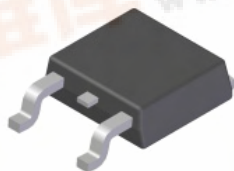
## Product Summary

$V_{(BR)DSS}$	$R_{DS(on)}$	$I_D$ $T_A = 25^\circ\text{C}$
20V	21m $\Omega$ @ $V_{GS} = 10\text{V}$	17.0A
	27m $\Omega$ @ $V_{GS} = 4.5\text{V}$	15.0A
	40m $\Omega$ @ $V_{GS} = 2.5\text{V}$	12.3A

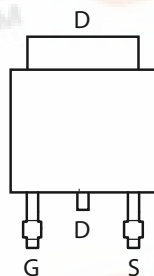
## Description and Applications

This new generation MOSFET has been designed to minimize the on-state resistance ( $R_{DS(on)}$ ) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

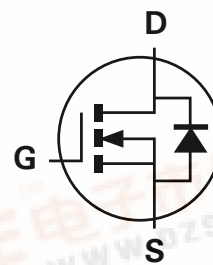
- Backlighting
- DC-DC Converters
- Power management functions



TOP VIEW



PIN OUT -TOP VIEW



Equivalent Circuit

## Features and Benefits

- Low on-resistance
- Fast switching speed
- Low gate drive
- "Green" component and RoHS compliant (Note 1)

## Mechanical Data

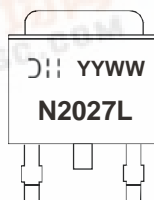
- Case: TO252-3L
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0 (Note 1)
- Moisture Sensitivity: Level 1 per J-STD-020D
- Terminals Connections: See Diagram
- Terminals: Matte Tin Finish annealed over Copper leadframe. Solderable per MIL-STD-202, Method 208
- Marking Information: See Below
- Ordering Information: See Below
- Weight: 0.33 grams (approximate)

## Ordering Information (Note 1)

Product	Marking	Reel size (inches)	Tape width (mm)	Quantity per reel
DMN2027LK3-13	N2027L	13	16	2,500

Note: 1. Diodes, Inc. defines "Green" products as those which are Eu RoHS compliant and contain no halogens or antimony compounds; further information about Diodes Inc.'s "Green" Policy can be found on our website. For packaging details, go to our website.

## Marking Information



D = Manufacturer's Marking  
N2027L = Product Type Marking Code  
YYWW = Date Code Marking  
YY = Year (ex: 09 = 2009)  
WW = Week (01-52)

**Maximum Ratings** @ $T_A = 25^\circ\text{C}$  unless otherwise specified

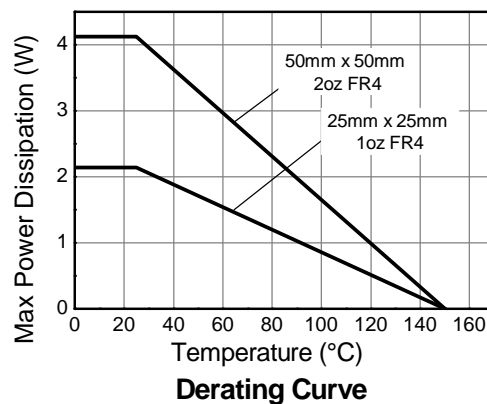
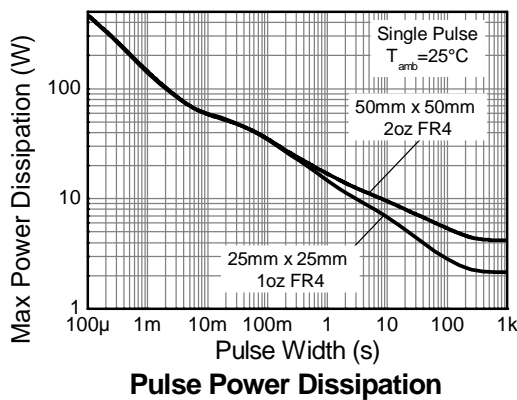
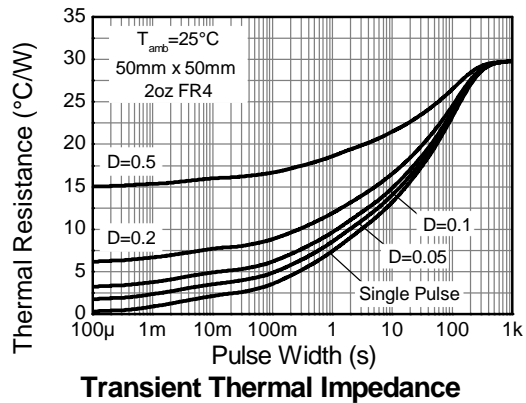
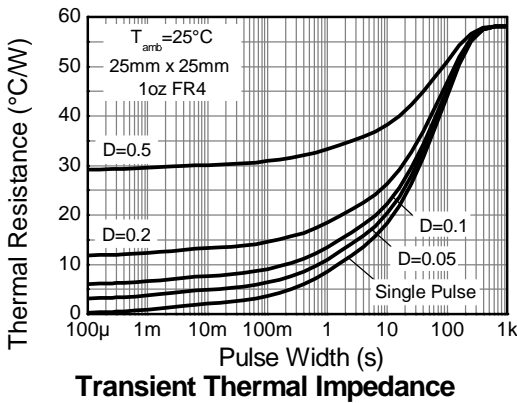
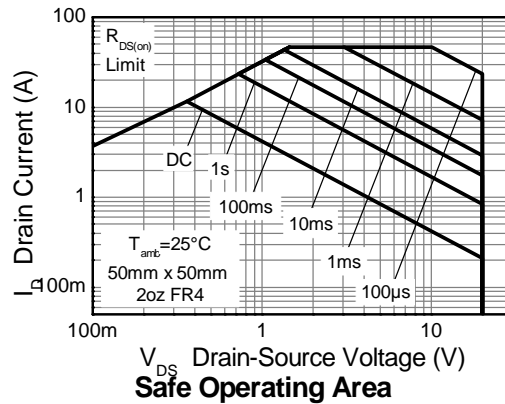
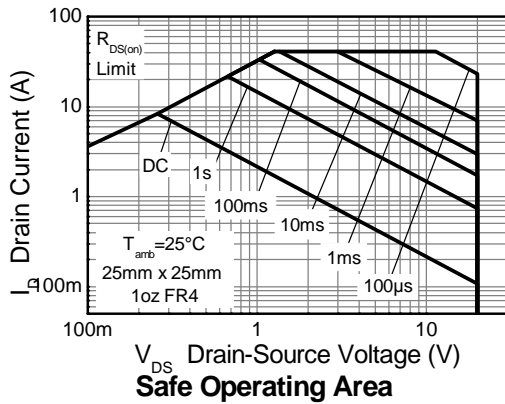
Characteristic			Symbol	Value	Unit	
Drain-Source voltage			$V_{DSS}$	20	V	
Gate-Source voltage			$V_{GS}$	$\pm 12$	V	
Continuous Drain current	$V_{GS} = 10\text{V}$	(Note 3)	$I_D$	17.0	A	
		$T_A = 70^\circ\text{C}$ (Note 3)		13.6		
		(Note 2)		11.6		
Pulsed Drain current	$V_{GS} = 10\text{V}$	(Note 4)	$I_{DM}$	46.8	A	
Continuous Source current (Body diode)			(Note 3)	$I_S$	11.9	A
Pulsed Source current (Body diode)			(Note 4)	$I_{SM}$	46.8	A

**Thermal Characteristics** @ $T_A = 25^\circ\text{C}$  unless otherwise specified

Characteristic			Symbol	Value	Unit
Power dissipation Linear derating factor	(Note 2)		$P_D$	4.18	W mW/ $^\circ\text{C}$
				33.44	
	(Note 3)			8.9	
				71.4	
	(Note 5)			2.14	
		17.1			
Thermal Resistance, Junction to Ambient	(Note 2)		$R_{\theta JA}$	29.9	$^\circ\text{C/W}$
	(Note 3)			14.0	
	(Note 5)			58.4	
Thermal Resistance, Junction to Lead	(Note 6)		$R_{\theta JL}$	2.46	
Operating and storage temperature range			$T_J, T_{STG}$	-55 to 150	$^\circ\text{C}$

- Notes:
- For a device surface mounted on 50mm x 50mm x 1.6mm FR4 PCB with high coverage of single sided 2oz copper, in still air conditions; the device is measured when operating in a steady-state condition.
  - Same as note 2, except the device is measured at  $t \leq 10$  sec.
  - Same as note 2, except the device is pulsed with  $D = 0.02$  and pulse width 300  $\mu\text{s}$ . The pulse current is limited by the maximum junction temperature.
  - For a device surface mounted on 25mm x 25mm x 1.6mm FR4 PCB with high coverage of single sided 1oz copper, in still air conditions; the device is measured when operating in a steady-state condition.
  - Thermal resistance from junction to solder-point (at the end of the drain lead).

**Thermal Characteristics**

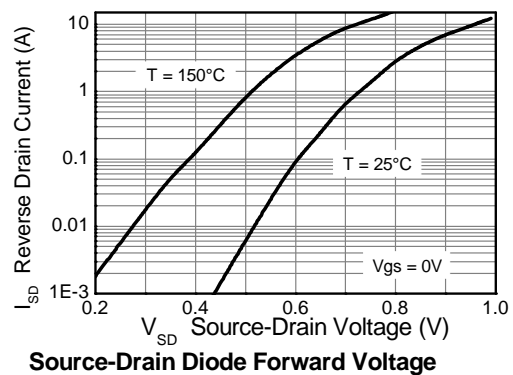
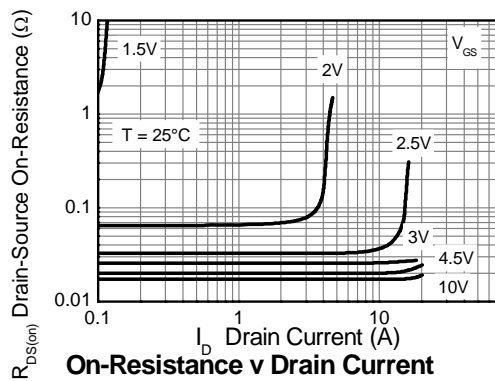
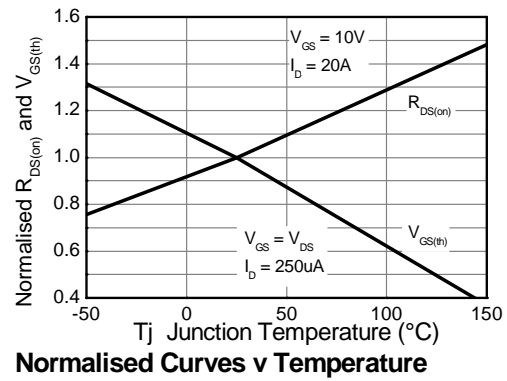
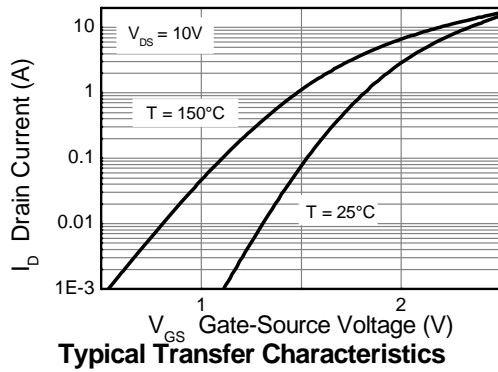
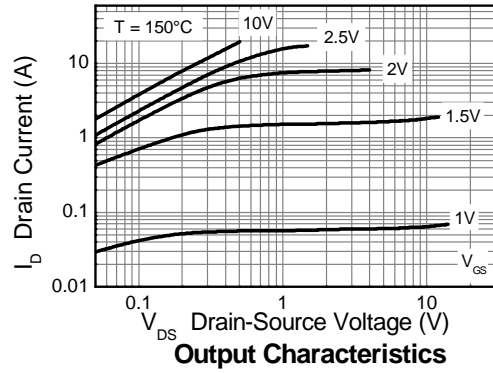
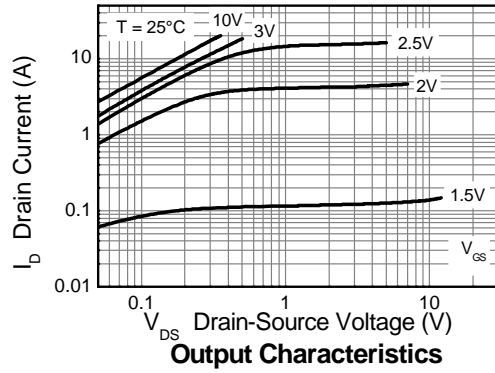


**Electrical Characteristics** @T<sub>A</sub> = 25°C unless otherwise specified

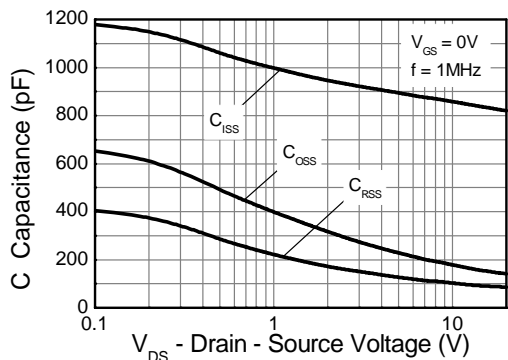
Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
<b>OFF CHARACTERISTICS</b>						
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	20	—	—	V	I <sub>D</sub> = 250μA, V <sub>GS</sub> = 0V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	—	—	0.5	μA	V <sub>DS</sub> = 20V, V <sub>GS</sub> = 0V
Gate-Source Leakage	I <sub>GSS</sub>	—	—	±100	nA	V <sub>GS</sub> = ±12V, V <sub>DS</sub> = 0V
<b>ON CHARACTERISTICS</b>						
Gate Threshold Voltage	V <sub>GS(th)</sub>	0.6	—	2.0	V	I <sub>D</sub> = 250μA, V <sub>DS</sub> = V <sub>GS</sub>
Static Drain-Source On-Resistance (Note 7)	R <sub>DS(on)</sub>	—	—	0.021	Ω	V <sub>GS</sub> = 10V, I <sub>D</sub> = 20A
				0.027		V <sub>GS</sub> = 4.5V, I <sub>D</sub> = 10A
				0.040		V <sub>GS</sub> = 2.5V, I <sub>D</sub> = 4A
Forward Transconductance (Notes 7 & 8)	g <sub>fs</sub>	—	31.7	—	S	V <sub>DS</sub> = 15V, I <sub>D</sub> = 10A
Diode Forward Voltage (Note 7)	V <sub>SD</sub>	—	0.89	1.0	V	I <sub>S</sub> = 10A, V <sub>GS</sub> = 0V
Reverse recovery time (Note 8)	t <sub>rr</sub>	—	121	—	ns	I <sub>S</sub> = 10A, di/dt = 100A/μs
Reverse recovery charge (Note 8)	Q <sub>rr</sub>	—	583	—	nC	
<b>DYNAMIC CHARACTERISTICS (Note 8)</b>						
Input Capacitance	C <sub>iss</sub>	—	857	—	pF	V <sub>DS</sub> = 10V, V <sub>GS</sub> = 0V f = 1MHz
Output Capacitance	C <sub>oss</sub>	—	177	—	pF	
Reverse Transfer Capacitance	C <sub>rss</sub>	—	102	—	pF	
Total Gate Charge	Q <sub>g</sub>	—	5.2	—	nC	V <sub>GS</sub> = 2.5V, I <sub>D</sub> = 4A
Total Gate Charge	Q <sub>g</sub>	—	9.1	—	nC	V <sub>GS</sub> = 4.5V I <sub>D</sub> = 10A
Gate-Source Charge	Q <sub>gs</sub>	—	1.9	—	nC	
Gate-Drain Charge	Q <sub>gd</sub>	—	3.2	—	nC	
Turn-On Delay Time (Note 9)	t <sub>D(on)</sub>	—	5.4	—	ns	V <sub>DD</sub> = 10V, V <sub>GS</sub> = 10V I <sub>D</sub> = 10A, R <sub>G</sub> ≅ 6.0Ω
Turn-On Rise Time (Note 9)	t <sub>r</sub>	—	22.3	—	ns	
Turn-Off Delay Time (Note 9)	t <sub>D(off)</sub>	—	18.7	—	ns	
Turn-Off Fall Time (Note 9)	t <sub>f</sub>	—	12.6	—	ns	

- Notes:
7. Measured under pulsed conditions. Pulse width ≤ 300μs; duty cycle ≤ 2%
  8. For design aid only, not subject to production testing.
  9. Switching characteristics are independent of operating junction temperatures.

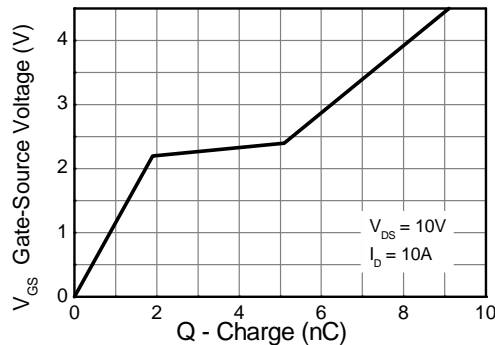
**Typical Characteristics**



**Typical Characteristics - continued**

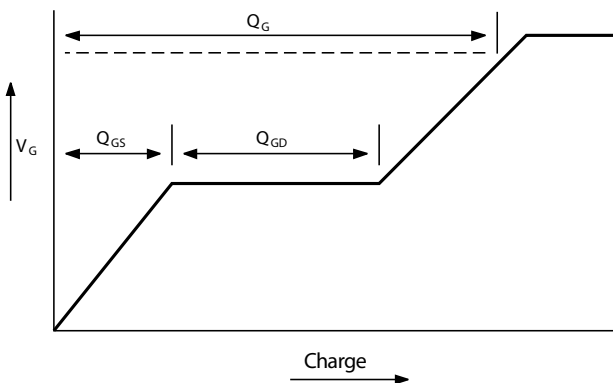


**Capacitance v Drain-Source Voltage**

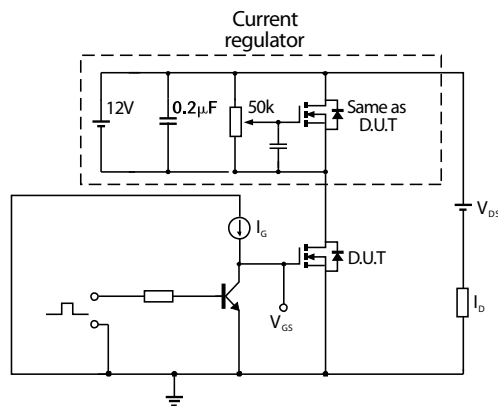


**Gate-Source Voltage v Gate Charge**

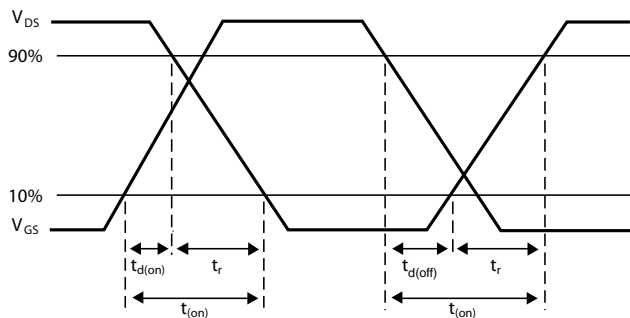
**Test Circuits**



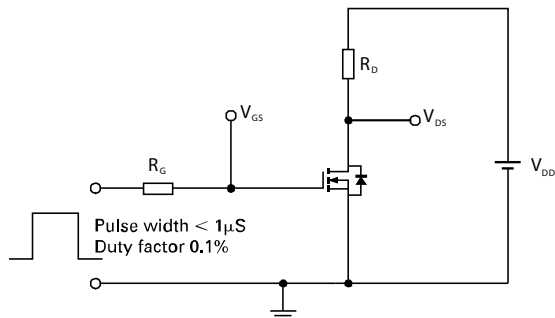
**Basic gate charge waveform**



**Gate charge test circuit**

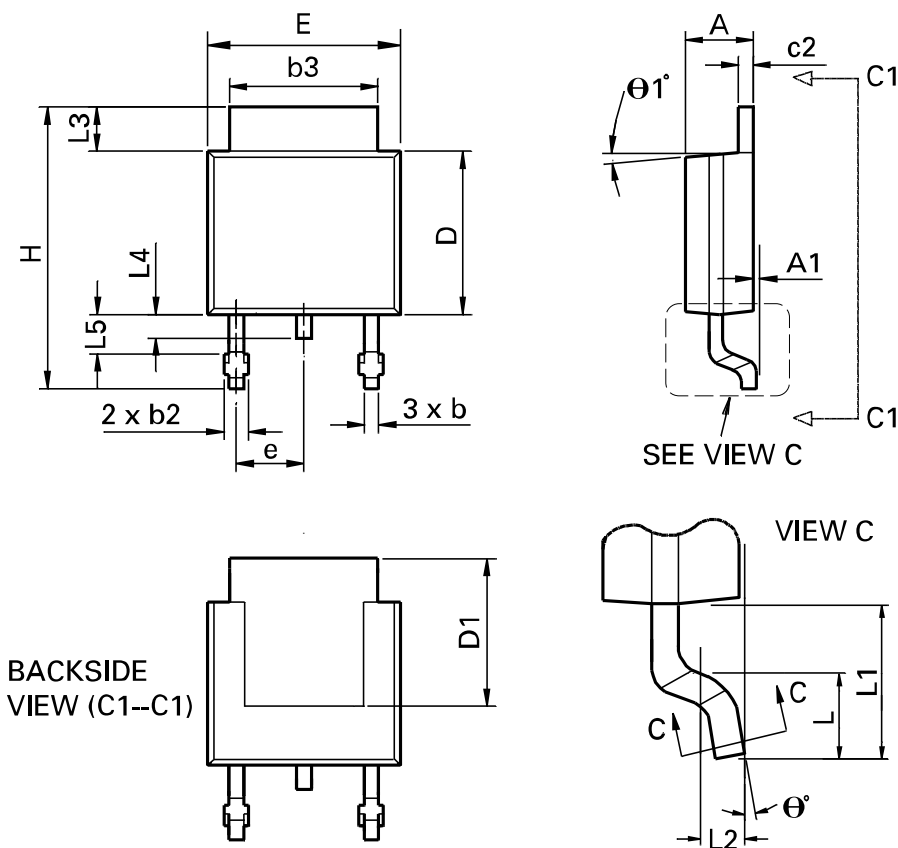


**Switching time waveforms**



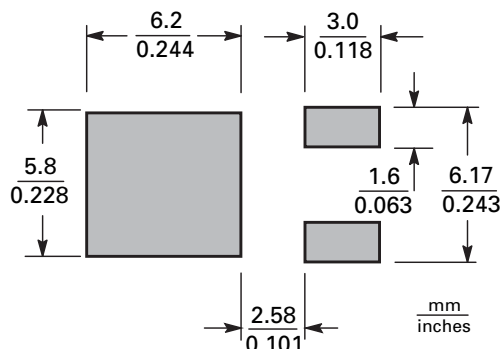
**Switching time test circuit**

**Package Outline Dimensions**



DIM	Inches		Millimeters		DIM	Inches		Millimeters	
	Min	Max	Min	Max		Min	Max	Min	Max
A	0.086	0.094	2.18	2.39	e	0.090 BSC		2.29 BSC	
A1	-	0.005	-	0.127	H	0.370	0.410	9.40	10.41
b	0.020	0.035	0.508	0.89	L	0.055	0.070	1.40	1.78
b2	0.030	0.045	0.762	1.14	L1	0.108 REF		2.74 REF	
b3	0.205	0.215	5.21	5.46	L2	0.020 BSC		0.508 BSC	
c	0.018	0.024	0.457	0.61	L3	0.035	0.065	0.89	1.65
c2	0.018	0.023	0.457	0.584	L4	0.025	0.040	0.635	1.016
D	0.213	0.245	5.41	6.22	L5	0.045	0.060	1.14	1.52
D1	0.205	-	5.21	-	$\theta_1^\circ$	0°	10°	0°	10°
E	0.250	0.265	6.35	6.73	$\theta^\circ$	0°	15°	0°	15°
E1	0.170	-	4.32	-	-	-	-	-	-

## Suggested Pad Layout



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